

IEEE 802.3da SPMD TF meeting

11 August 2021

Prepared by Peter Jones

Presentations posted at:

<https://www.ieee802.org/3/da/index.html>

Agenda/Admin - Chad Jones

All times in Pacific Time (PT)

7:01am: The Chair reviewed the agenda. The Chair asked if there were any corrections or additions to the agenda. There being no corrections or additions, the agenda stands approved.

The Chair noted that the minutes for the July Teleconference were only published recently, so will not be asking for approval today.

7:07am: Call for patents (see below) was made, no one responded. From the "INSTRUCTIONS FOR THE WG CHAIR" slide:

- Instruct the WG Secretary to record in the minutes of the relevant WG meeting:
 - That the foregoing information was provided and that slides 1 through 4 (and this slide 0, if applicable) were shown;
 - That the chair or designee provided an opportunity for participants to identify patent claim(s)/patent application claim(s) and/or the holder of patent claim(s)/patent application claim(s) of which the participant is personally aware and that may be essential for the use of that standard
 - Any responses that were given, specifically the patent claim(s)/patent application claim(s) and/or the holder of the patent claim(s)/patent application claim(s) that were identified (if any) and by whom.

7:14am: Opening agenda slides complete. The meeting moves on to presentations.

Presentations/Discussion.

7:14am: Discussion of comment cycle, timeline, work items, etc

Current cycle closed with zero comments

Extend current cycle, new close date EOD Sep 12 AOE, proposed resolutions available Sep 20th.

Timeline slipping again.

7:45am: discussion done.

7:45am: meeting breaks until 8:00am

8:00am: meeting resumes

"SPE Multidrop Enhancements Mixing Segment Considerations" presentation postponed to next meeting

8:01am: Closing remarks

Next meeting: August 25th, 7:00am PT.

Meeting closed - 8:03am PT

Attendees (from Webex + emails)

Name	Employer	Affiliation	Attended 08/11
Bob Voss	Panduit Corp.	Panduit Corp.	y
Brian Murray	Analog Devices Inc.	Analog Devices Inc.	y
Chad Jones	Cisco Systems, Inc.	Cisco Systems, Inc.	y
David D. Brandt	Rockwell Automation	Rockwell Automation	y
Denis Beaudoin	Texas Instruments	Texas Instruments	y
Emilio Cuesta	TE Connectivity	TE Connectivity	y
George Zimmerman	CME Consulting	ADI, APL Group, Cisco Systems, CommScope, Marvell, SenTekSe	y
Gergely Huszak	Self	Kone	y
Guadalupe Chalas	Phoenix Contact	Phoenix Contact	y
Haruka Yoshimura	TDK	TDK	y
Heath Stewart	Analog Devices Inc.	Analog Devices Inc.	y
James Withey	Fluke	Fluke	y
Jason Potterf	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Joe Aronson	Texas Instruments	Texas Instruments	y
Ken Schneider	Telebyte Inc	Telebyte Inc	y
Matthias Fritsche	HARTING Technologie Gruppe	HARTING Technologie Gruppe	y
McKenzie Reed	HARTING Technology Group	HARTING Technology Group	y
Michael Paul	Analog Devices Inc.	Analog Devices Inc.	y
Paul Vanderlaan	UL LLC	UL LLC	y
Peter Fischer	BKS Kabel-Service AG	BKS Kabel-Service AG	y
Peter Jones	Cisco Systems, Inc.	Cisco Systems, Inc.	y
Piergiorgio Beruto	Canova Tech	Canova Tech	y
Ralf Peteranderl	Rosenberger	Rosenberger	y
Rich Boyer	Aptiv Signal and Power Solutions	Aptiv Signal and Power Solutions	y
Sami Akin	Volkswagen AG	Volkswagen AG	y
Scott Wade	WadeLux Limited	DiiA	y
T Kobayashi	TDK	TDK	y
Tim Baggett	Microchip Technology, Inc.	Microchip Technology, Inc.	y
Valerie Maguire	Siemon	Siemon	y
Wensheng Sun	Marvell	Marvell	y
Wojciech Koczwar	Rockwell Automation	Rockwell Automation	y
Yung-Le Chang	Realtek	Realtek	y
Attendees			32